

Wieland-K16

Cu-ETP1/CW003A

Material designation

EN	Cu-ETP1/CW003A
UNS	-

Chemical composition*

Cu + O	$\geq 99.99 \%$
with oxygen not desoxidized	$\leq 140 \text{ ppm}$

*Reference values in % by weight

Physical properties*

Electrical conductivity	MS/m	≥ 58
	%IACS	≥ 100
Thermal conductivity	W/(m·K)	>385
Thermal expansion coefficient (0–300 °C)	$10^{-6}/\text{K}$	17.7
Density	g/cm³	8.93
Modulus of elasticity	GPa	127

*Reference values at room temperature

Material properties and typical applications

Wieland-K16 is a copper with a low oxygen content. It exhibits good electrical and thermal conductivity. Due to the oxygen content its use at an elevated temperature in a reducing atmosphere is critical, especially if a hydrogen-containing atmosphere (hydrogen embrittlement) is concerned. This means there are certain restrictions during annealing as well as welding and soldering. Main applications are within the superconductor technology.

This material is more pure than C11000. RRR values (293K/4,2K) ≥ 300 can be achieved.

Corrosion resistance

Handelsmarken

RESISTAN®

Further information is provided in the brochure on RESISTAN.

Product standards

Wire	EN 13602
Section	

Types of delivery

The BU Extruded Products supplies bars, wire, sections and tubes. Please get in touch with your contact person regarding the available delivery forms, dimensions and tempers.

Fabrication properties

Forming

Machinability (CuZn39Pb3 = 100 %)	20 %
Capacity for being cold worked	excellent
Capacity for being hot worked	fair

Surface treatment

Polishing	good
mechanical electrolytic	excellent
Electroplating	excellent

Joining

Resistance welding (butt weld)	good
Inert gas shielded arc welding	fair
Hard soldering	good
Soft soldering	excellent

Heat treatment

Melting range	1083 °C
Hot working	750–900 °C
Soft annealing	250–500 °C 1–3 h
Thermal stress relieving	150–200 °C 1–3 h